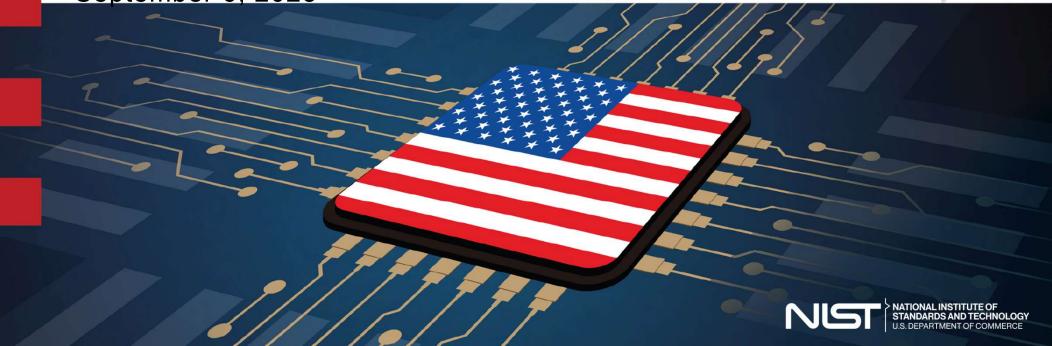
### **CHIPS for America**

#### Adrienne Elrod, Director of External and Government Affairs

CHIPS Webinar

September 6, 2023







# **Overview of CHIPS for America**

### **CHIPS for America Vision**



#### Economic Security

The CHIPS Act will strengthen supply chain security and increase economic resilience in critical sectors.



#### National Security

The CHIPS Act will ensure that the U.S. can manufacture advanced technologies, including secure chips for the U.S. military.



### Future Innovation

The CHIPS Act will spur innovation, increase competitiveness, and ensure long-term U.S. leadership in the sector





### **CHIPS for America**

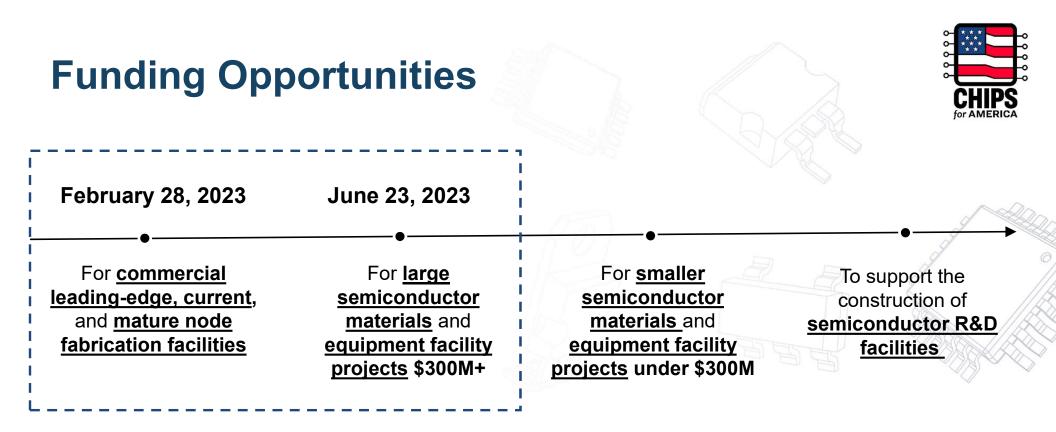
1.

2.

#### \$39 billion for incentives \$11 billion for R&D Four integrated programs to: Two component programs: Conduct research and 1. Attract largeprototyping of advanced scale investments in semiconductor technology advanced technologies such Strengthen semiconductor 2. as leading-edge logic and advanced test, assembly, and memory packaging Incentivize expansion Enable advances in 3 of manufacturing capacity measurement science. for mature and other types of standards, material semiconductors characterization, instrumentation, testing, and manufacturing

Workforce development

Plus CHIPS initiatives from other agencies, including DOD, State, NSF, and Treasury



Statements of Interest currently being accepted for all funding opportunities

1. Overview of the CHIPS program

### **Vision for Success**



#### Leading-Edge Logic

- ✓ The U.S. will have at least two new large-scale clusters of leading-edge logic fabs
- U.S.-based engineers will develop the process technologies underlying the next gen of logic chips

#### □ Memory

- ✓ U.S.-based fabs will produce high-volume memory chips on economically competitive terms
- R&D for next-generation memory technologies critical to supercomputing and other advanced computing applications will be conducted in the U.S.



#### Advanced Packaging

- The U.S. will be home to multiple high-volume advanced packaging facilities
- The U.S. will be a global leader in commercialscale advanced packaging technology

By the end of the decade…

#### **Current-Generation and Mature**

- The U.S. will have strategically increased its production capacity for current-gen and mature chips
- Chipmakers will also be able to respond more nimbly to supply and demand shocks

### **Vision for Success – Materials and Equipment Facilities**



#### Strengthen Supply Chain Resilience

- ✓ The U.S. and its allies will reduce chokepoint risks flowing from geographic concentration
- Supply chain participants will improve the transparency of demand and supply to reduce the risks of production disruptions



#### Advance U.S. Technology Leadership

- The U.S. will have incentivized major U.S.
   equipment and materials suppliers to increase their footprints in the U.S.
- Non-U.S. suppliers of the world's most advanced equipment, materials, and subsystems will also establish large-scale footprints in the U.S.

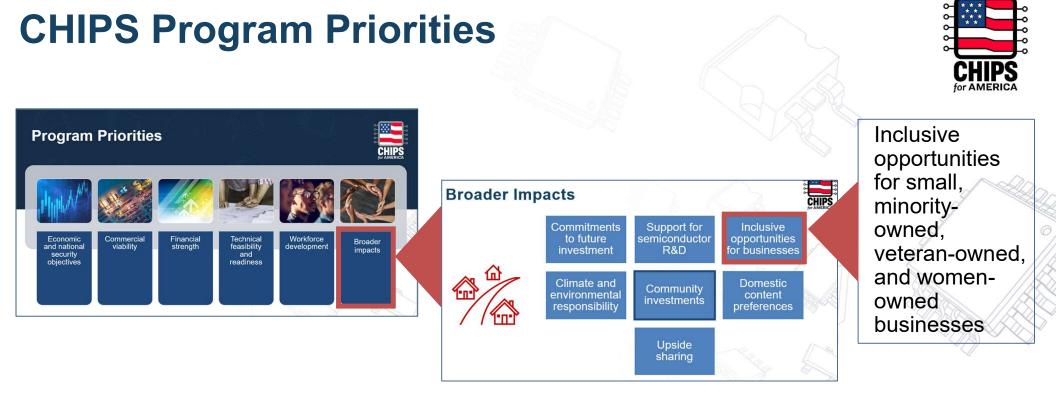


- Each CHIPS-funded fab cluster in the U.S. will be supported by dozens of suppliers, including many investing in the U.S. for the first time
- State and local entities encouraged to help facilitate the expansion of these ecosystems

### **Program Priorities**







Commitments to inclusive business opportunities are **important to the success** of the CHIPS program.

National Institute of Standards and Technology | U.S. Department of Commerce 9 CHIPS | U.S. Department of Commerce

### **Economic Security**

SEEKING PROJECTS THAT



- Increase U.S. semiconductor production and align with U.S. strategic needs
- · Create a more resilient semiconductor supply chain
- Build foundry or other capacity to serve many different customers
- Attract supplier, workforce, and other investments
- Contribute to a self-sustaining ecosystem and catalyze future upgrades

#### Leading-edge

- Use the most advanced tech and produce products that are most critical to enhancing U.S. competitiveness
- Commit to ongoing investment in U.S.

### Current-generation and mature-node

- Support production of chips vital to automobiles, aerospace and defense, and other critical infrastructure
- Use processes that convert to make other types of chips in times of disruption

#### **Back-end production**

Advanced packaging







### **National Security**

#### SEEKING PROJECTS THAT



Produce semiconductors that are relied upon by the Department of Defense, other government systems, or by critical infrastructure

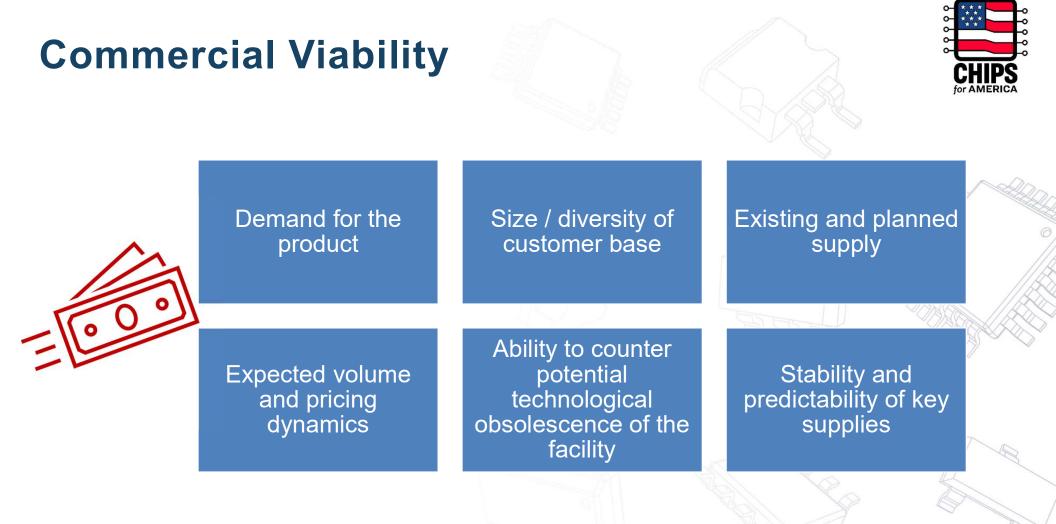
Support U.S. government national security needs, such as by providing U.S. government access to facility output, or adapting commercial production for low-volume and high-mix national security components

Mitigate operational and cybersecurity risks

Strengthen supply chain resilience by analyzing and managing risks to their own supply chains

Ensure that foreign entities of concern will not pose undue risks

Produce mature-node semiconductors that are then supplied to critical manufacturing industries



National Institute of Standards and Technology | U.S. Department of Commerce

12



13

### Financial Strength

Financial strength of the applicant / parent

Financial strength of the project

Commitment of private/thirdparty investment Reasonableness / suitability of CHIPS funding request



### **Technical Feasibility and Readiness**







15

### **Workforce Development**

Create good jobs



Recruit, hire, train, and retain a diverse and skilled construction and manufacturing workforce

Include women and economically disadvantaged individuals

Engage with community partners

Child care



#### **Broader Impacts** Commitments Support for Inclusive to future semiconductor opportunities R&D investment for businesses п Climate and Domestic Community environmental content יחי investments responsibility preferences Upside sharing

National Institute of Standards and Technology | U.S. Department of Commerce

16



**Application Process** 



# **Smaller Supply Chain Projects**

### **Smaller Supply Chain Project Overview**



19

Construct, expand, or modernize a semiconductor material facility or semiconductor equipment facility

Capital investment below \$300 million

Focus on supporting vibrant, competitive, self-sustaining U.S. fabrication clusters

More details will be made available in a dedicated notice of funding opportunity later this year

### **Smaller Supply Chain Project Details**



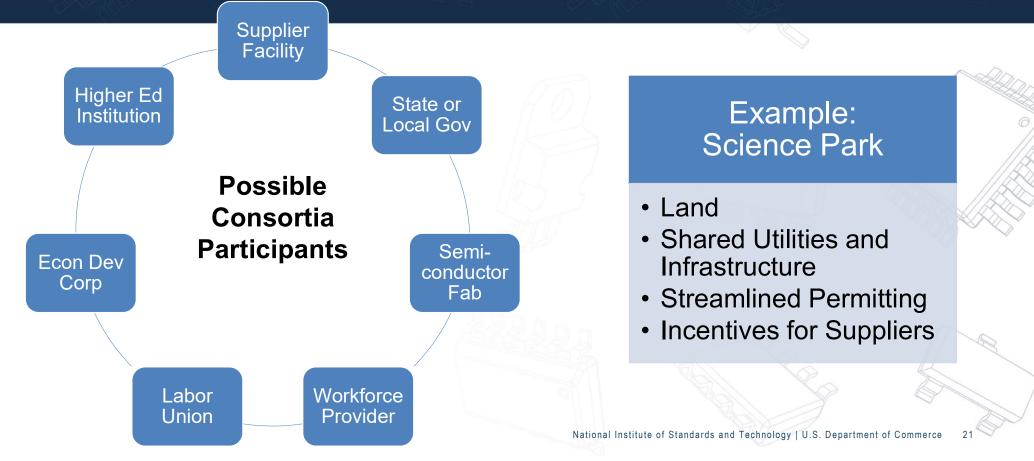
20

Consortia	Project Types	Tailored Application Process	1 Alton
<ul> <li>Strong focus on consortium applications that promote the development and sustainability of semiconductor clusters</li> <li>Consortia may include a diverse array of entities</li> </ul>	<ul> <li>The Department intends to reserve its funding to support investments that would not happen without CHIPS funding</li> </ul>	<ul> <li>Dedicated funding opportunity will include a different application process that smaller businesses can easily navigate</li> </ul>	
	1		

More details will be made available in a dedicated notice of funding opportunity later this year









### Opportunity and Inclusion for Small Businesses

### **Inclusive Business Opportunities Vision**

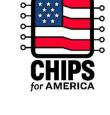
The CHIPS & Science Act will:

**Grow the economy** of the United States and support **job creation** in the United States;

Promote the **inclusion of historically and economically disadvantaged communities** and **small businesses**; and

Contribute to **community-based economic development** and **empowerment** as well as **innovation** and **supply chain resiliency** within the semiconductor industry.

National Institute of Standards and Technology | U.S. Department of Commerce



23



# To achieve this vision, the Department is prioritizing applications that...



**Describe their supplier diversity** plan, including the components of their strategy.



Work with **partners to identify and engage with** small, minority-owned, veteran-owned, and women-owned businesses.

3

**Track and disclose data** on supplier diversity and pursue other proactive engagement opportunities.

This guide will help applicants think through the best models that work for them and submit strong supplier diversity plans

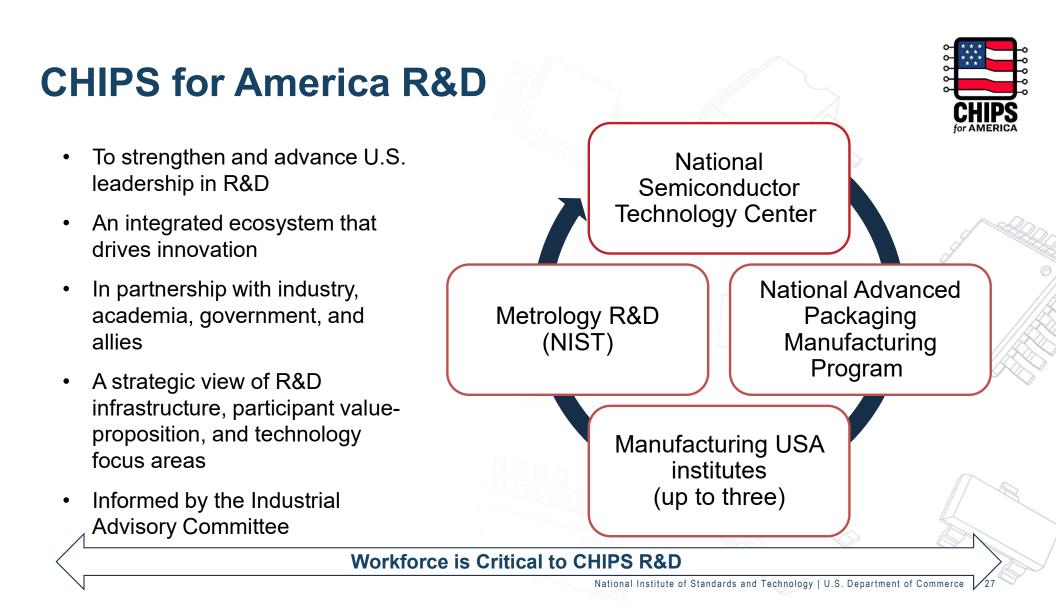


National Institute of Standards and Technology | U.S. Department of Commerce

25



# **Research and Development**



### Vision for Success – R&D



#### Tools

- The U.S. will have a core of world-leading research and engineering capabilities and a network of technical centers throughout the country
- U.S. innovators will have access to research fabs, prototyping facilities, and digital resources to bring technology to commercial scale



#### Innovation

- ✓ More U.S.-based start-ups will enter the market, faster and at less expense
- ✓ The cost of moving a new chip from lab to fab will be cut in half in the U.S.



#### Collaboration

- The U.S. will provide pre-competitive spaces where members of industry, academia, and government and allies work together to build the technologies of the future
- The community will establish grand challenges and roadmaps to inspire and guide R&D in the U.S.



#### Workforce

- The U.S. will triple the number of college graduates and people retrained in chip-related fields
- U.S. students will train on current and cuttingedge equipment at CHIPS facilities
- The U.S. will double the number of women, veterans, and others from under-represented communities in the chip industry

National Institute of Standards and Technology | U.S. Department of Commerce



28



# Resources



### **New Resource: Teaming Partner List**



- The teaming partner list will enable entities to share information, foster collaboration, and advance shared goals
  - Entities that may not be eligible to apply can share contact information and capabilities
  - Potential applicants can access and reach out to entities on the list to facilitate potential partnerships and collaboration
  - This list does not directly connect entities to potential applicants, but is meant to enable potential strategic partnerships



- Consider signing up for the teaming list if you:
  - Are an entity that may not qualify as covered entities under the CHIPS funding opportunities
  - Are an organization that provides relevant support services
  - This could include: educational and workforce training providers; labor unions; childcare providers; organizations that engage or support minority-owned, women-owned, and veteran-owned businesses; community-based organizations; and others

More details at: https://www.nist.gov/chips/chips-america-teaming-partner-list



### **Next Steps**

- Visit <u>CHIPS.gov</u> for resources, including:
  - Applicant guides and templates
  - FAQs and fact sheets
- Register for future webinars
- Join our mailing list
- Contact us
  - <u>askchips@chips.gov</u> General inquiries
  - <u>apply@chips.gov</u> Application-related inquiries





# Thank You



## Questions